



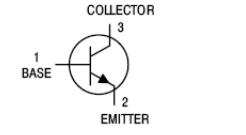
MMBT2222AM

SOT-723 Bipolar Transistor(NPN)



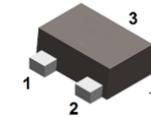
Features

- Epitaxial die construction
- Complementary PNP type available (MMBT2907AM)
- Ultra-small surface mount package



Mechanical Data

- Case: SOT-723
- Molding compound: UL flammability classification rating 94V-0
- Terminals: Tin-plated; solderability per MIL-STD-202, Method 208



SOT-723

Ordering Information

| Part Number | Package | Shipping Quantity | Marking Code |
|-------------|---------|-------------------------|--------------|
| MMBT2222AM | SOT-723 | 10000 pcs / Tape & Reel | 1P |

Maximum Ratings (@ $T_A = 25^\circ\text{C}$ unless otherwise specified)

| Parameter | Symbol | Value | Unit |
|---|-----------|-------|------|
| Collector-Base Voltage | V_{CBO} | 75 | V |
| Collector-Emitter Voltage | V_{CEO} | 40 | V |
| Emitter-Base Voltage | V_{EBO} | 6 | V |
| Collector Current (Continuous) | I_C | 600 | mA |
| Collector Current - Peak pulse width $\leq 40\mu\text{s}$, $\delta = 0.35$ | I_{CM} | 1.5 | A |
| Continuous Base Current | I_B | 0.15 | A |
| Peak Base Current | I_{BM} | 0.2 | A |

Thermal Characteristics

| Parameter | Symbol | Value | Unit |
|--|-----------------|------------|------|
| Power Dissipation *1 | P_D | 0.15 | W |
| Thermal Resistance Junction-to-Air *1 | $R_{\theta JA}$ | 833 | °C/W |
| Thermal Resistance Junction-to-Air *2 | $R_{\theta JA}$ | 190 | °C/W |
| Thermal Resistance Junction-to-Case *2 | $R_{\theta JC}$ | 110 | °C/W |
| Thermal Resistance Junction-to-Lead *2 | $R_{\theta JL}$ | 100 | °C/W |
| Ambient Temperature | T_A | -55 ~ +150 | °C |
| Operating Junction Temperature | T_J | -55 ~ +150 | °C |
| Storage Temperature Range | T_{STG} | -55 ~ +150 | °C |



Electrical Characteristics (@ T_A = 25°C unless otherwise specified)

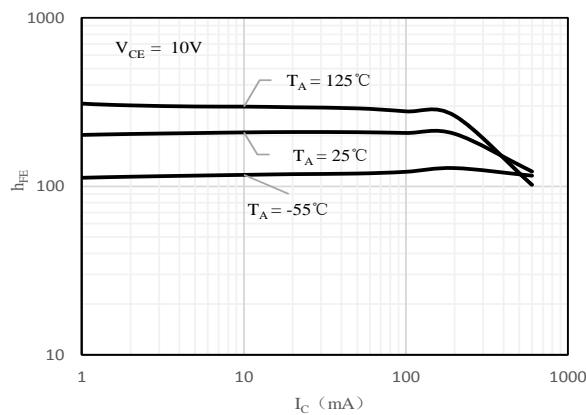
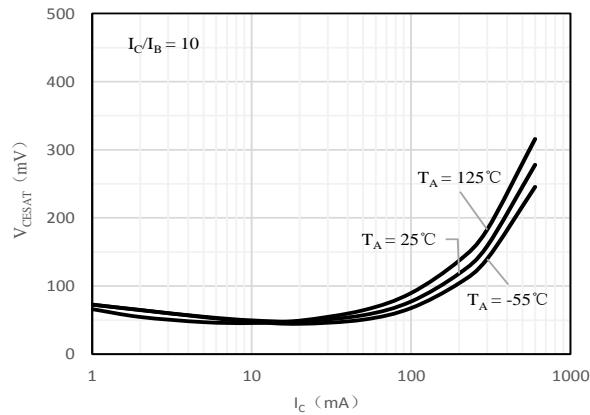
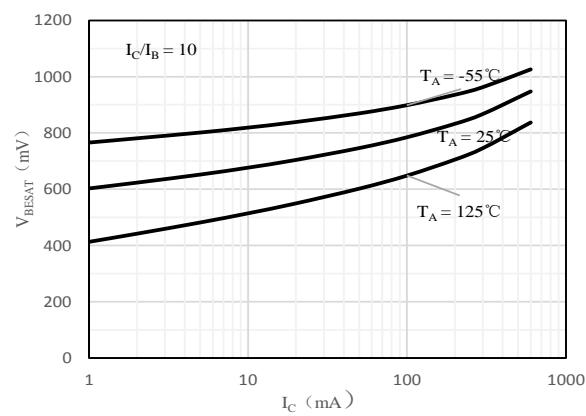
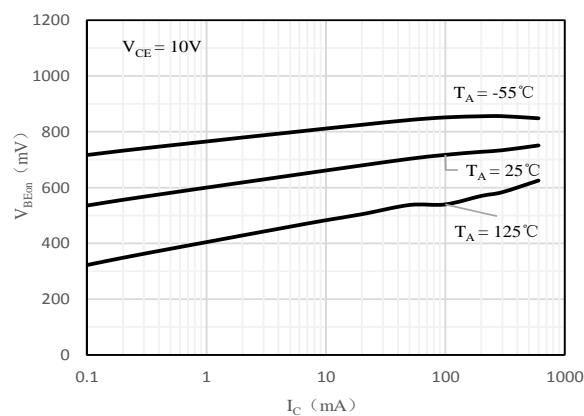
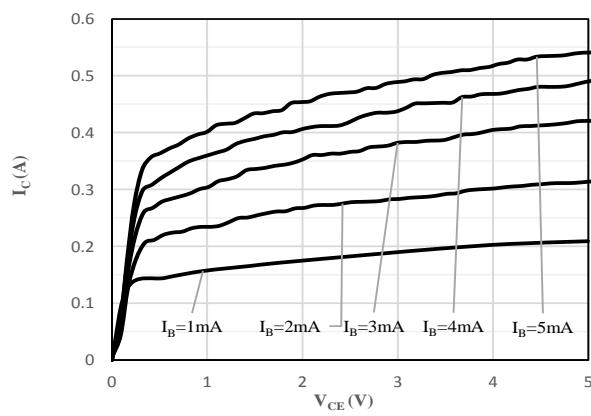
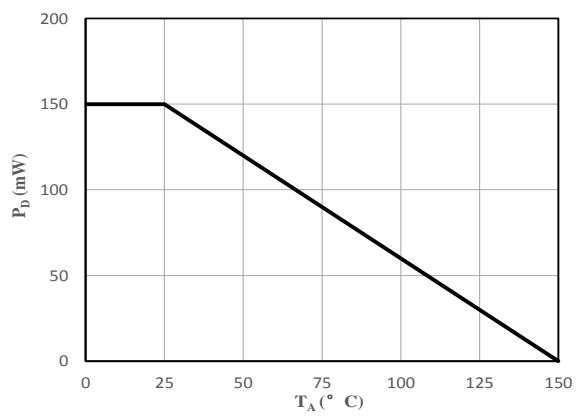
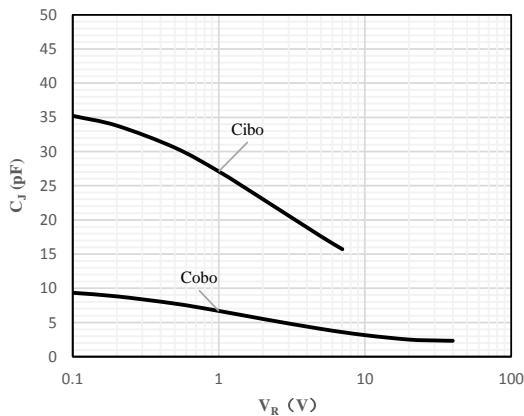
| Parameter | Symbol | Test Condition | Min. | Typ. | Max. | Unit |
|--------------------------------------|----------------------|---|------|------|------|------|
| Collector-Base Breakdown Voltage | V _{(BR)CBO} | I _C = 10µA, I _E = 0 | 75 | - | - | V |
| Collector-Emitter Breakdown Voltage | V _{(BR)CEO} | I _C = 10mA, I _B = 0 | 40 | - | - | V |
| Emitter-Base Breakdown Voltage | V _{(BR)EBO} | I _E = 10µA, I _C = 0 | 6 | - | - | V |
| Collector Cut-off Current | I _{CBO} | V _{CB} = 60V, I _E = 0 | - | - | 10 | nA |
| Collector Cut-off Current | I _{CEX} | V _{CE} = 60V, V _{BE} = 3V | - | - | 10 | nA |
| Emitter Cut-off Current | I _{EBO} | V _{EB} = 3V, I _C = 0 | - | - | 10 | nA |
| DC Current Gain | h_{FE} | V _{CE} = 10V, I _C = 0.1mA | 35 | - | - | - |
| | | V _{CE} = 10V, I _C = 1mA | 50 | - | - | - |
| | | V _{CE} = 10V, I _C = 10mA | 75 | - | - | - |
| | | V _{CE} = 10V, I _C = 150mA | 100 | - | 300 | - |
| | | V _{CE} = 10V, I _C = 500mA | 40 | - | - | - |
| Collector-Emitter Saturation Voltage | V _{CE(sat)} | I _C = 500mA, I _B = 50mA | - | - | 1 | V |
| | | I _C = 150mA, I _B = 15mA | - | - | 0.3 | V |
| Base-Emitter Saturation Voltage | V _{BE(sat)} | I _C = 500mA, I _B = 50mA | - | - | 2 | V |
| | | I _C = 150mA, I _B = 15mA | - | 0.6 | 1.2 | V |
| Base-Emitter Voltage | V _{BE(on)} | I _C = 200mA, V _{CE} = 10V | - | - | 1 | V |
| Transition Frequency | f _T | V _{CE} = 20V, I _C = 20mA f = 100MHz | 300 | - | - | MHz |
| Output Capacitance | C _{CEO} | V _{CB} = 10V, I _E = 0 f = 1MHz | - | - | 8 | pF |
| Noise Figure | N _F | V _{CE} = 10V, I _C = 100µA R _S = 1.0KΩ, f = 1.0kHz | - | - | 4.0 | dB |
| Delay Time | t _d | V _{CC} = 30V, I _C = 150mA V _{BE(OFF)} = -0.5V, I _{B1} = 15mA | - | - | 10 | ns |
| Rise Time | t _r | | - | - | 25 | ns |
| Storage Time | t _s | V _{CC} = 30V, I _C = 150mA I _{B1} = -I _{B2} = 15mA | - | - | 225 | ns |
| Fall Time | t _f | | - | - | 60 | ns |

Notes:

1. FR-5 = 1.0 * 0.75 * 0.062 in
2. The data tested by surface mounted on a 1 inch² FR-4 board with 2OZ copper

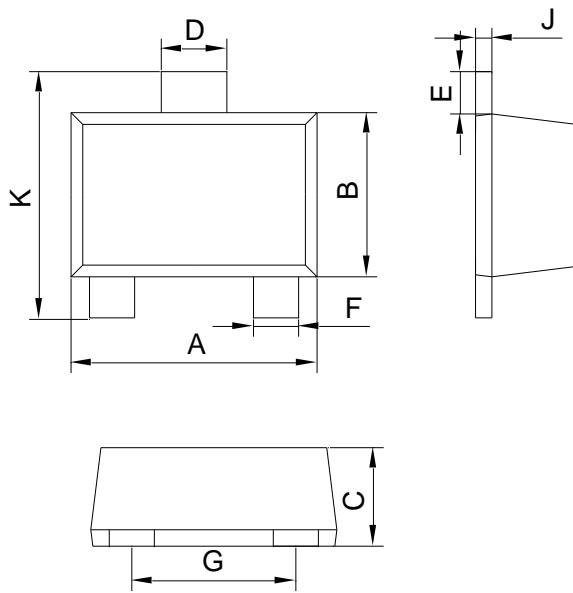


Ratings and Characteristics Curves (@ $T_A = 25^\circ\text{C}$ unless otherwise specified)


Fig 1 h_{FE} vs. I_c

Fig 2 $V_{CE(sat)}$ vs. I_c

Fig 3 $V_{BE(sat)}$ vs. I_c

Fig 4 $V_{BE(on)}$ vs. I_c

Fig 5 I_c vs. V_{CE}

Fig 6 P_D vs. T_A

Fig 7 C_J vs. V_R



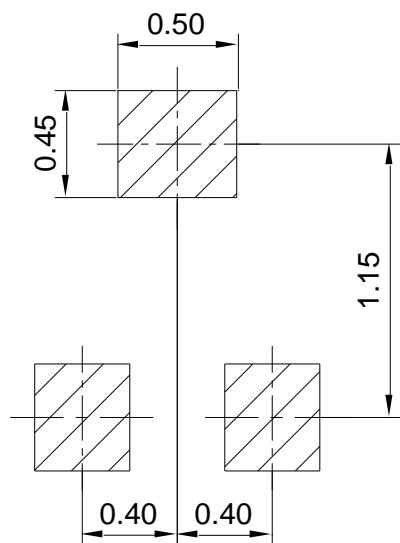
Package Outline Dimensions (Unit: mm)



| SOT-723 | | |
|-----------|------|------|
| Dimension | Min. | Max. |
| A | 1.10 | 1.30 |
| B | 0.70 | 0.90 |
| C | 0.40 | 0.54 |
| D | 0.22 | 0.42 |
| E | 0.10 | 0.30 |
| F | 0.12 | 0.32 |
| G | 0.70 | 0.90 |
| J | 0.08 | 0.15 |
| K | 1.10 | 1.30 |

Mounting PAD Layout (Unit: mm)

SOT-723



| Package | Reel | Reel Size | Box | Box Size(mm) | Carton | Carton Size(mm) |
|----------|---------|-----------|------------|--------------|------------|-----------------|
| SOT -723 | 8000pcs | 7inch | 120,000pcs | 203×203×195 | 480,000pcs | 438×438×220 |